



#### 50A BIDIRECTIONAL SURFACE MOUNT THYRISTOR SURGE PROTECTION DEVICE

#### **Features**

- 50A Peak Pulse Current @ 10/1000μs
- 250A Peak Pulse Current @ 8/20μs
- 58 320V Stand-Off Voltages
- Oxide-Glass Passivated Junction
- Bidirectional Protection In a Single Device
- High Off-State impedance and Low On-State Voltage
- Helps Equipment Meet GR-1089-CORE, IEC 61000-4-5, FCC Part 68, ITU-T K.20/K.21, and UL497B
- UL Listed Under Recognized Component Index, File Number 156346
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

#### **Mechanical Data**

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: None; Bidirectional Devices Have No Polarity Indicator
- Weight: 0.093 grams (approximate)





Top View

Bottom View

#### Ordering Information (Note 3)

Part Number	Case	Packaging
TB0640M-13-F	SMB	3000/Tape & Reel
TB0720M-13-F	SMB	3000/Tape & Reel
TB0900M-13-F	SMB	3000/Tape & Reel
TB1100M-13-F	SMB	3000/Tape & Reel
TB1300M-13-F	SMB	3000/Tape & Reel
TB1500M-13-F	SMB	3000/Tape & Reel
TB1800M-13-F	SMB	3000/Tape & Reel
TB2300M-13-F	SMB	3000/Tape & Reel
TB2600M-13-F	SMB	3000/Tape & Reel
TB3100M-13-F	SMB	3000/Tape & Reel
TB3500M-13-F	SMB	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at  $\mbox{\sc http://www.diodes.com.}$

### **Marking Information**



xxxxx = Product type marking code (See Electrical Characteristics table on page 3)

| = Manufacturers' code marking

YWW = Date code marking

Y = Last digit of year (ex: 2 for 2002)

WW = Week code (01 to 53)

TB0640M - TB3500M Document number: DS30361 Rev. 10 - 2



### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

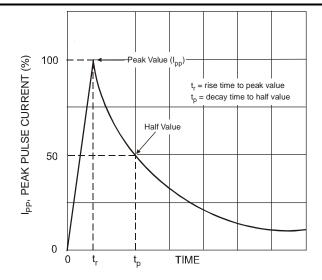
Characteristic			Value	Unit
Non-Repetitive Peak Impulse Current	@10/1000us	I <sub>pp</sub>	50	Α
Non-Repetitive Peak On-State Current	@8.3ms (one-half cycle)	I <sub>TSM</sub>	30	Α
Typical Positive Temperature Coefficient for Breakdown Voltage		$\Delta VBR/\Delta T_j$	0.1	%/°C

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Lead	$R_{ heta JL}$	20	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	100	°C/W
Junction Temperature Range	$T_J$	-40 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

### **Maximum Rated Surge Waveform**

Waveform	Standard	Ipp (A)
2/10 us	GR-1089-CORE	300
8/20 us	IEC 61000-4-5	250
10/160 us	FCC Part 68	150
10/700 us	ITU-T, K.20/K.21	100
10/560 us	FCC Part 68	75
10/1000 us	GR-1089-CORE	50





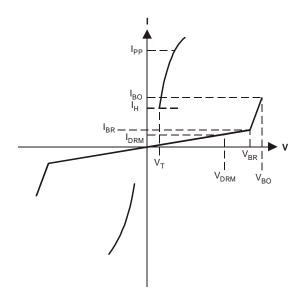
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Part Number	Maximum Rated Repetitive Off-State Voltage	Maximum Off-State Leakage Current @ VDRM	Maximum Breakover Voltage	Maximum On-State Voltage @ I <sub>T</sub> = 1A	Cur	kover rent	Holding I	Current	Typical Off-State Capacitance	Marking Code
	V <sub>DRM</sub> (V)	I <sub>DRM</sub> (uA)	V <sub>BO</sub> (V)	V <sub>T</sub> (V)	Min (mA)	Max (mA)	Min (mA)	Max (mA)	C <sub>O</sub> (pF)	
TB0640M	58	5	77	3.5	50	800	150	800	140	T064M
TB0720M	65	5	88	3.5	50	800	150	800	140	T072M
TB0900M	75	5	98	3.5	50	800	150	800	140	T090M
TB1100M	90	5	130	3.5	50	800	150	800	90	T110M
TB1300M	120	5	160	3.5	50	800	150	800	90	T130M
TB1500M	140	5	180	3.5	50	800	150	800	90	T150M
TB1800M	160	5	220	3.5	50	800	150	800	90	T180M
TB2300M	190	5	265	3.5	50	800	150	800	60	T230M
TB2600M	220	5	300	3.5	50	800	150	800	60	T260M
TB3100M	275	5	350	3.5	50	800	150	800	60	T310M
TB3500M	320	5	400	3.5	50	800	150	800	60	T350M

Symbol	Parameter
V <sub>DRM</sub>	Stand-off Voltage
I <sub>DRM</sub>	Leakage current at stand-off voltage
$V_{BR}$	Breakdown voltage
I <sub>BR</sub>	Breakdown current
$V_{BO}$	Breakover voltage
I <sub>BO</sub>	Breakover current
lн	Holding current Note 4
$V_{T}$	On state voltage
I <sub>PP</sub>	Peak pulse current
Co	Off-state capacitance Note 5

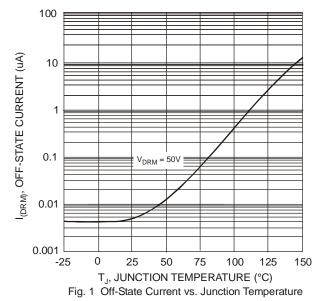
Notes:

<sup>5.</sup> Off-state capacitance measured at f = 1.0MHz, 1.0V  $_{RMS}$  signal,  $V_{R}$  =  $2V_{DC}$  bias.



<sup>4.</sup> I<sub>H</sub> > (V<sub>L</sub>/R<sub>L</sub>) If this criterion is not obeyed, the TSPD triggers but does not return correctly to high-resistance state. The surge recovery time does not exceed 30ms.





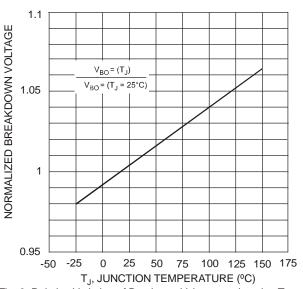


Fig. 3 Relative Variation of Breakover Voltage vs. Junction Temperature

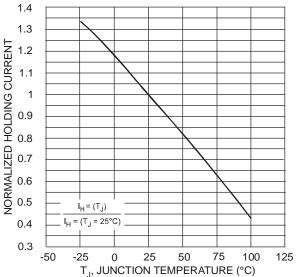


Fig. 5 Relative Variation of Holding Current vs. Junction Temperature

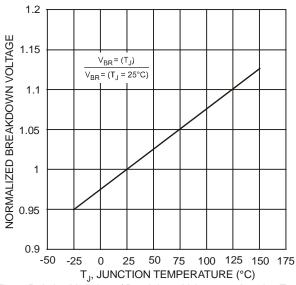


Fig. 2 Relative Variation of Breakdown Voltage vs. Junction Temperature

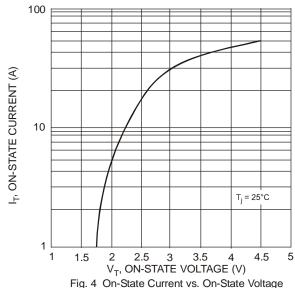


Fig. 4 On-State Current vs. On-State Voltage

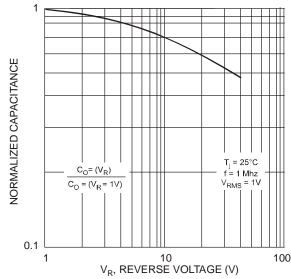
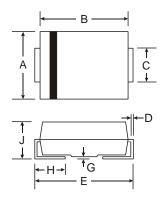


Fig. 6 Relative Variation of Junction Capacitance vs. Reverse Voltage Bias

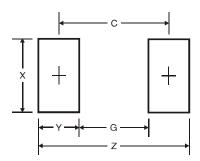


# Package Outline Dimensions



SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
C	1.96	2.21		
D	0.15	0.31		
Е	5.00	5.59		
G	0.05	0.20		
Н	0.76	1.52		
7	2.00	2.50		
All Dimensions in mm				

## **Suggested Pad Layout**



SMB Dimensions	Value (in mm)
Z	6.8
G	1.8
Х	2.3
Υ	2.5
С	4.3



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